## ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18 Stylesheet Version v18.0

Title of Invention

Molded Stiffener for Thin Substrates

Application Number :

10/077554 3265

Confirmation Number: First Named Applicant:

Chad Cobblev

Attorney Docket Number:

MTI-31591

Art Unit: Examiner: 2814 Hoa B. Trinh

Search string:

( 6326544 or 6724071 ).pn

## **US Patent Documents**

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
	1	6326544	2001-12-04	Lake		174	52.2
	2	6724071	2004-04-20	Combs		257	666

## Signature

Examiner Name	Date